TIC225 series

SEMICONDUCTOR TECHNICAL DATA

TIC225 Series(8A TRIACS)

8A RMS TO-220 PACKAGE

400V to 800V Off-State Voltage

 $Max I_{GT} of 5mA(Quadrant 1)$

ABSOLUTE RATING

Symbol	Parameter		Value	Units
$ m V_{DRM}$	Repetitive peak off-state voltage	TIC225D TIC225M TIC225S TIC225N	400 600 700 800	V
I _{T(RMS)}	Continuous on-state current at(or below) 70 case temperature		8	A
I_{TSM}	Peak on-state surge current full-sine-wave		70	A
I _{TSM}	Peak on-state surge current half-sine-wave		80	A
I_{GM}	Peak gate current		±1	A
P _{GM}	Peak gate power dissipation(pulse width 200 µ s)		2.2	W
$P_{G(AV)}$	Average gate power dissipation		0.9	W
T_{C}	Operating case temperature range		-40 ~ 110	
$T_{ m stg}$	Storage temperature		-40 ~ 125	



THERMAL RESISTANCE

Symbol	Parameter	Value	Unit
Rth(j-c)	Junction to case thermal resistance	2.5	/W
Rtj(j-a)	Junction to free air thermal resistance	62.5	/W

ELECTRICAL CHARACTERISTICS at 25 case temperature

Symbol	Testing conditions	Min.	Тур.	Max.	Unit
$\mathbf{I}_{\mathbf{GT}}$	V_{supply} =+12V, R_L =10 , $t_{p(g)} > 20 \mu s$	-	0.8	5	mA
	$V_{\text{supply}} = +12V, R_L = 10 , t_{p(g)} > 20 \mu s$	-	-4.5	-20	
	V_{supply} =-12V, R_L =10 , $t_{p(g)} > 20 \mu s$	•	-3.5	-10	
	V_{supply} =-12V, R_L =10 , $t_{p(g)} > 20 \mu \text{ s}$	-	11.7	30	
$ m V_{GT}$	$V_{\text{supply}}=+12V, R_L=10 , t_{p(g)} > 20 \mu s$	-	0.7	2	V
	$V_{\text{supply}}=+12V, R_L=10 , t_{p(g)} > 20 \mu s$	-	-0.7	-2	
	V_{supply} =-12V, R_L =10 , $t_{p(g)} > 20 \mu s$	-	-0.8	-2	
	V_{supply} =-12V, R_L =10 , $t_{p(g)} > 20 \mu s$	-	0.9	2	
I_{H}	V_{supply} =+12V, I_G =0, Initiating I_T =100mA	-	3	20	mA
	$ m V_{supply}$ =-12V, $ m I_G$ =0, Initiating $ m I_T$ =-100mA	-	-4.7	-20	
$\mathbf{V}_{\mathbf{TM}}$	I_{TM} = ± 12A , I_{G} =50mA	-	-	± 1.7	V
$I_{ m DRM}$	V_D =rated V_{DRM} , I_G =0, T_C =110	-	± 1.6	± 2.1	mA
dv/dt	V_{DRM} =rated V_{DRM} , I_{TRM} = ± 3.5A, T_{C} =110	-	± 50	-	V/µs